ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	Material Composit © Copyright 2005. IPC, international and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a decla he declaratio	ration of on encom	the substance the substance appasses all low	es within ver level	the manufactur materials for w	rer listed it which the m	em. Not anufact	te: if the urer has	item is an asso engineering re	embly with lowe sponsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information					
Supplier Informa	tion															
Company name*	Company unique ID				Unique ID Authority					Respons	Response Date*					
onsemi										2025-06	2025-06-04					
Contact Name	Title - Contact				Phone - Contact*					Email -	Email - Contact*					
Product-Env-Steward	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com						
Authorized Representative*			Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester			n Number Mfr Item Name				Effective D	ate Ve	ersion	Manufacturing Site		1	Weight*	:	UOM	Unit Type
			7SMNR2G	MNR2G ANA DUAL TRANSLATOR			2025-06-04 MY1			23.69 n		mg	Each			
Manufacturing P	roccess Information	L		·			·					I				
Terminal Plating / Grid Array Material		al T	erminal Base A	ninal Base Alloy J-ST		L Rating	Peak P	Peak Process Body Temperate		ure Max Time at Peak Te		Temperat	Temperature Number		Reflow Cycle	es
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		С	30	30 se		seconds 3			
Comments							· · · · · · · · · · · · · · · · · · ·		·			·	<u> </u>			
evel 1 - maximum tin	ne at peak temperature d	luring sol	dering is 10-3	0 seconds												
For more information	n regarding material com	position	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.25	mg	Supplier	Silicon (Si)	7440-21-3		0.25	mg
Die Attach	0.65	mg	Supplier	Silver (Ag)	7440-22-4		0.4875	mg
			Supplier	Epoxy resins	129915-35-1		0.1625	mg
Lead Frame	10.08	mg	Supplier	Tin (Sn)	7440-31-5		0.0252	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0222	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0252	mg
			Supplier	Copper (Cu)	7440-50-8		10.0074	mg
Mold Compound-Black	12.09	mg		Epoxy resin	proprietary data		0.5682	mg
			Supplier	Phenol Resin	Proprietary Data		0.5682	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0121	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.9415	mg
Plating	0.48	mg	Supplier	Palladium (Pd)	7440-05-3		0.0115	mg
			В	Nickel (Ni)	7440-02-0		0.4224	mg
			Supplier	Gold (Au)	7440-57-5		0.0461	mg
Wire Bond - Au	0.14	mg	Supplier	Gold (Au)	7440-57-5		0.14	mg